10/25/2013



PRODUCT RELIABILITY REPORT FOR

DS2484

Maxim Integrated

14460 Maxim Dr. Dallas, TX 75244

Approved by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim Integrated products:

DS2484

In addition, Maxim Integrated's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maximintegrated.com/qa/reliability/monitor.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://www.maximintegrated.com/search/parts.mvp.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts AfT = Acceleration factor due to Temperature tu = Time at use temperature (e.g. 55°C) ts = Time at stress temperature (e.g. 125°C) k = Boltzmann's Constant (8.617 x 10-5 eV/°K) Tu = Temperature at Use (°K) Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu)) AfV = Acceleration factor due to Voltage Vs = Stress Voltage (e.g. 7.0 volts) Vu = Maximum Operating Voltage (e.g. 5.5 volts) B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)X = Chi-Sq statistical upper limit N = Life test sample size Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE:	MTTF (YRS):	11591 FITS:		9.8
	DEVICE HOURS:	93034004	FAILS:	0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.25 V	Volts
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The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information	n:								
Process: Passivation: Die Size: Number of Transistors: Interconnect:		Maxim X3 Fab S18M 5V CMOS, 2V CMOS, 4 metals SiN / SiO2 57 x 40 21438 Aluminum / 0.5% Copper							
Gate Oxide Thick	iness:	140A							
ESD HBM									
DESCRIPTION	DATE	CODE/PRODUCT	LOT CONDITION		READPOIN		QTY	FAILS	FA#
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 500 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 1500 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 4000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 6000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1319	DS2484	ZJ332803AD	JESD22-A114 HBM 8000 VOLTS	1	PUL'S	5	0	
					Total:			0	
LATCH-UP									
DESCRIPTION	DATE CODE/PRODUCT/LOT		CONDITION	READPOIN		QTY	FAILS	FA#	
LATCH-UP I	1319	DS2484	ZJ332803AD	JESD78A, I-TEST 25C 100mA			6	0	
LATCH-UP I	1319	DS2484	ZJ332803AD	JESD78A, I-TEST 25C 250mA			6	0	

LATCH-UP V	1319	DS2484	ZJ332803AD	JESD7 TEST	78A, V-SUPPLY 25C			6	0	
						Total:			0	
OPERATING LIFE										
DESCRIPTION	DATE	CODE/PRODUCT/	LOT	COND	ITION	READ	POIN	QTY	FAILS	FA#
HIGH TEMP OP LIFE	1018	DS28E10	QH000900A	125C,	3.6 VOLTS	192	HRS	45	0	
HIGH TEMP OP LIFE	1244	DS2483	ZJ330302AE	125C,	5.25 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	1319	DS2484	ZJ332803AD	125C,	5.25 VOLTS	1000	HRS	45	0	
						Total:			0	
FAILURE RATE:		MTTF (YRS)	: 11	591	FITS:	9.8				
	D	EVICE HOURS	: 93034	004	FAILS:	0				

Cumulative monitor data for the S18 Process results in a FIT Rate of 0.05 @ 25C and 0.93 @ 55C (0.8 Ev, 60% UCL).